

Applications

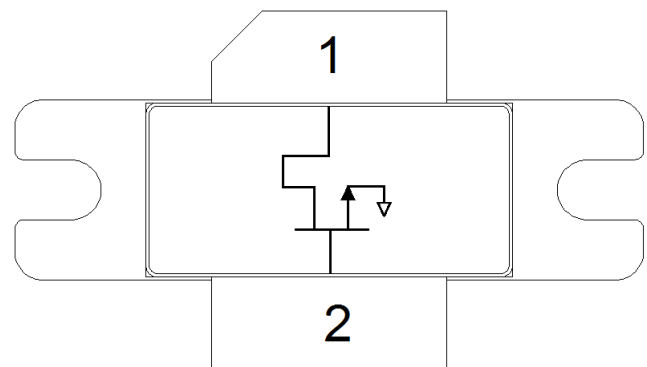
- Military radar
- Civilian radar
- Professional and military radio communications
- Test instrumentation
- Wideband or narrowband amplifiers
- GPS Communications
- Avionics



Product Features

- Frequency: DC to 2.0 GHz
- Output Power (P_{3dB}): 260 W at 1.2 GHz
- Linear Gain: 18 dB at 1.2 GHz
- Operating Voltage: 36 V
- Low thermal resistance package

Functional Block Diagram



General Description

The TriQuint T1G2028536-FL is a 285 W (P_{3dB}) discrete GaN on SiC HEMT which operates from DC to 2 GHz. The device is constructed with TriQuint's proven TQGaN25HV process, which features advanced field plate techniques to optimize power and efficiency at high drain bias operating conditions. This optimization can potentially lower system costs in terms of fewer amplifier line-ups and lower thermal management costs.

Lead-free and ROHS compliant

Evaluation boards are available upon request.

Pin Configuration

Pin No.	Label
1	V_D / RF OUT
2	V_G / RF IN
Flange	Source

Ordering Information

Part	ECCN	Description
T1G2028536-FL	EAR99	Packaged part Flanged
T1G2028536-FL-EVB1	EAR99	1.2 – 1.4 GHz Evaluation Board

Absolute Maximum Ratings

Parameter	Value
Breakdown Voltage ($V_{D(G)}$)	145 V (Min.)
Drain Gate Voltage ($V_{D(G)}$)	48 V
Gate Voltage Range (V_G)	-7 to 0 V
Drain Current (I_D)	24 A
Gate Current (I_G)	-57 to 67 mA
Power Dissipation (P_D)	260 W
RF Input Power, CW, $T = 25^\circ\text{C}$ (P_{IN})	47 dBm
Channel Temperature (T_{CH})	275 °C
Mounting Temperature (30 Seconds)	320 °C
Storage Temperature	-40 to 150 °C

Operation of this device outside the parameter ranges given above may cause permanent damage. These are stress ratings only, and functional operation of the device at these conditions is not implied.

Recommended Operating Conditions

Parameter	Value
Drain Voltage (V_D)	36 V (Typ.)
Drain Quiescent Current (I_{DQ})	576 mA (Typ.)
Peak Drain Current (I_D)	1.33 A (Typ.)
Gate Voltage (V_G)	-3.0 V (Typ.)
Channel Temperature (T_{CH})	250 °C (Max)
Power Dissipation, CW (P_D)	226 W
Power Dissipation, Pulse (P_D)	288 W

Electrical specifications are measured at specified test conditions. Specifications are not guaranteed over all recommended operating conditions.

RF Characterization – Load Pull Performance at 1.0 GHz ⁽¹⁾

Test conditions unless otherwise noted: $T_A = 25^\circ\text{C}$, $V_D = 36\text{ V}$, $I_{DQ} = 576\text{ mA}$

Symbol	Parameter	Min	Typical	Max	Units
G_{LIN}	Linear Gain		20.8		dB
P_{3dB}	Output Power at 3 dB Gain Compression		316.0		W
DE_{3dB}	Drain Efficiency at 3 dB Gain Compression		66.7		%
PAE_{3dB}	Power-Added Efficiency at 3 dB Gain		65.6		%
G_{3dB}	Gain at 3 dB Compression		17.8		dB

Notes:

- $V_{DS} = 36\text{ V}$, $I_{DQ} = 576\text{ mA}$; Pulse: 300 μs , 10%

RF Characterization – Load Pull Performance at 2.0 GHz ⁽¹⁾

Test conditions unless otherwise noted: $T_A = 25^\circ\text{C}$, $V_D = 36\text{ V}$, $I_{DQ} = 576\text{ mA}$

Symbol	Parameter	Min	Typical	Max	Units
G_{LIN}	Linear Gain		19.4		dB
P_{3dB}	Output Power at 3 dB Gain Compression		268.9		W
DE_{3dB}	Drain Efficiency at 3 dB Gain Compression		56.3		%
PAE_{3dB}	Power-Added Efficiency at 3 dB Gain		55.1		%
G_{3dB}	Gain at 3 dB Compression		16.4		dB

Notes:

- $V_{DS} = 36\text{ V}$, $I_{DQ} = 576\text{ mA}$; Pulse: 300 μs , 10%

RF Characterization – Performance at 1.2 GHz ^(1, 2)

Test conditions unless otherwise noted: $T_A = 25\text{ }^\circ\text{C}$, $V_D = 36\text{ V}$, $I_{DQ} = 576\text{ mA}$

Symbol	Parameter	Min	Typical	Max	Units
G_{LIN}	Linear Gain	17.0	18.7		dB
P_{3dB}	Output Power at 3 dB Gain Compression	230.0	264.5		W
DE_{3dB}	Drain Efficiency at 3 dB Gain Compression	49.0	54.0		%
G_{3dB}	Gain at 3 dB Compression	14.0	15.7		dB

Notes:

- Performance at 1.2 GHz in the 1.2 to 1.4 GHz Evaluation Board
- $V_{DS} = 36\text{ V}$, $I_{DQ} = 576\text{ mA}$; Pulse: 300 μ s, 10%

RF Characterization – Narrow Band Performance at 1.2 GHz ⁽¹⁾

Test conditions unless otherwise noted: $T_A = 25\text{ }^\circ\text{C}$, $V_D = 36\text{ V}$, $I_{DQ} = 576\text{ mA}$

Symbol	Parameter	Typical
VSWR	Impedance Mismatch Ruggedness	10:1

Notes:

- $V_{DS} = 36\text{ V}$, $I_{DQ} = 576\text{ mA}$, CW at P_{1dB}

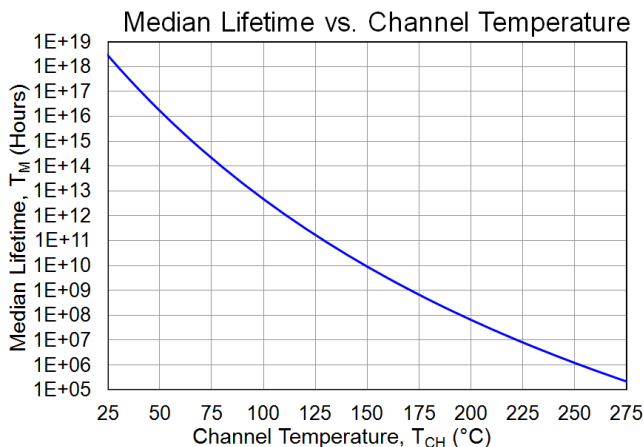
Thermal and Reliability Information

Parameter	Test Conditions	Value	Units
Thermal Resistance (θ_{JC})	Vd = 36V, DC at 85°C Case CW	0.73	°C/W
Channel Temperature (T_{CH})		250	°C
Thermal Resistance (θ_{JC})	Vd = 36 V, DC at 85°C Case 100 usec, 10% duty cycle	0.36	°C/W
Channel Temperature (T_{CH})		167	°C
Thermal Resistance (θ_{JC})	Vd = 32 V, DC at 85°C Case 100 usec, 20% duty cycle	0.39	°C/W
Channel Temperature (T_{CH})		175	°C
Thermal Resistance (θ_{JC})	Vd = 32 V, DC at 85°C Case 300 usec, 10% duty cycle	0.43	°C/W
Channel Temperature (T_{CH})		184	°C
Thermal Resistance (θ_{JC})	Vd = 32 V, DC at 85°C Case 300 usec, 20% duty cycle	0.46	°C/W
Channel Temperature (T_{CH})		192	°C

Notes:

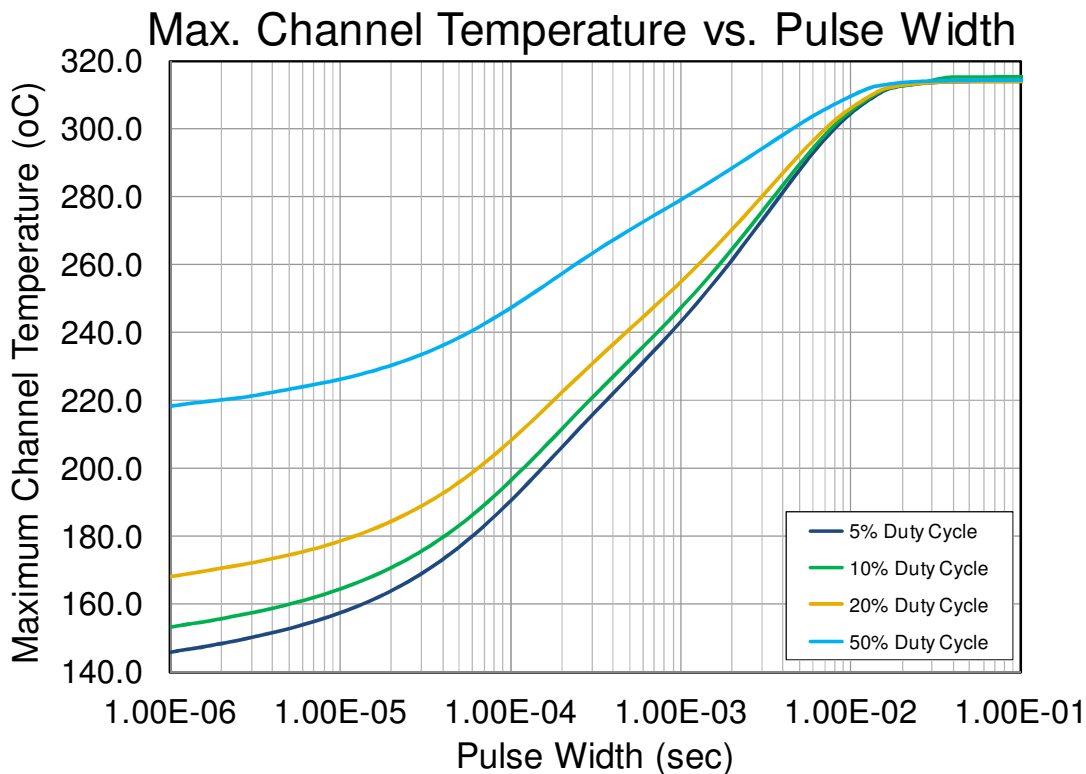
Thermal resistance measured to bottom of package

Median Lifetime



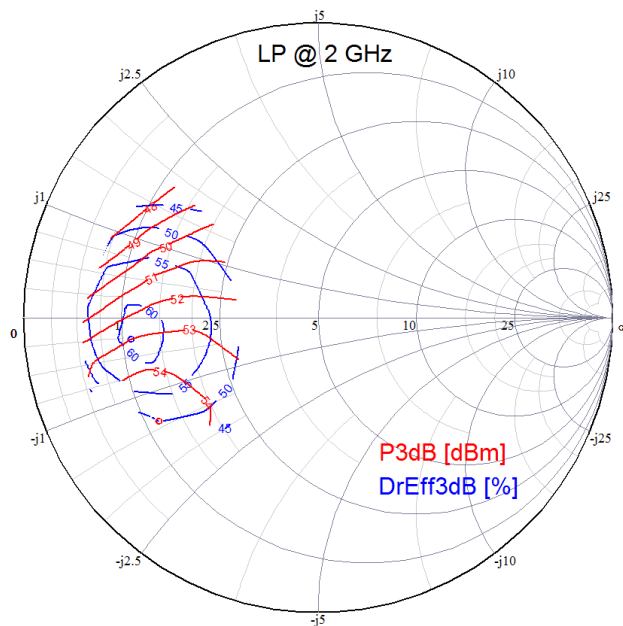
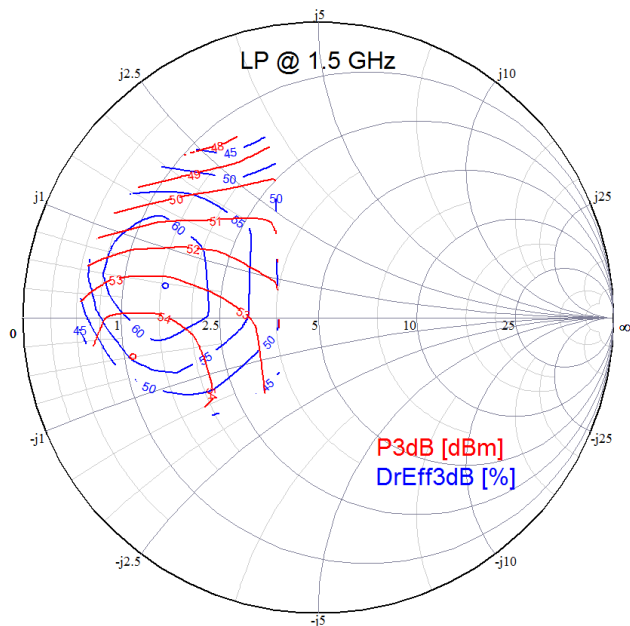
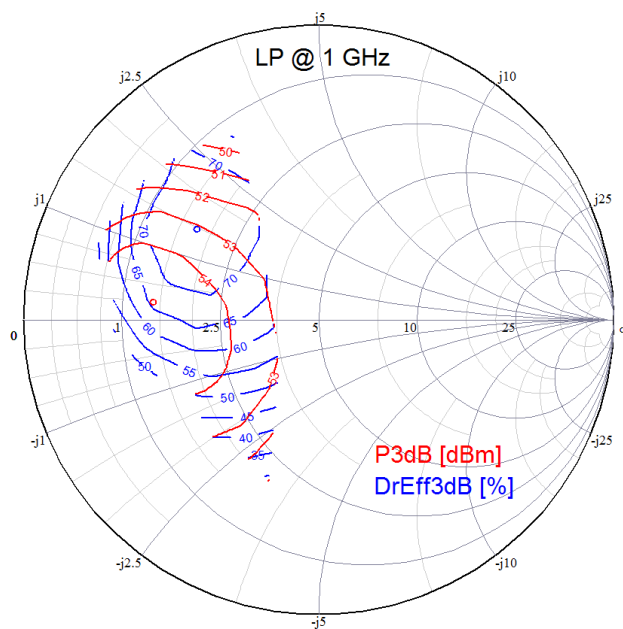
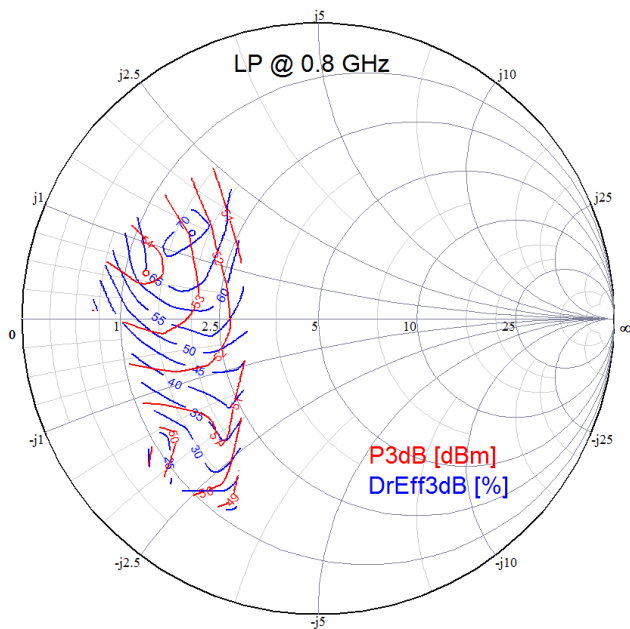
Maximum Channel Temperature

$T_{BASE} = 85^\circ\text{C}$, $P_D = 288\text{ W}$



Load Pull Smith Charts (1, 2)

RF performance that the device typically exhibits when placed in the specified impedance environment. The impedances are not the impedances of the device, they are the impedances presented to the device via an RF circuit or load-pull system. The impedances listed follow an optimized trajectory to maintain high power and high efficiency.



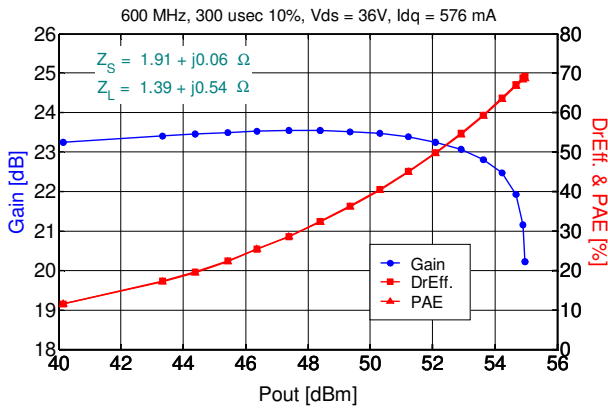
Notes:

1. Test Conditions: $V_{DS} = 36\text{ V}$, $I_{DQ} = 576\text{ mA}$
2. Test Signal: Pulse Width = 100 μsec , Duty Cycle = 20%

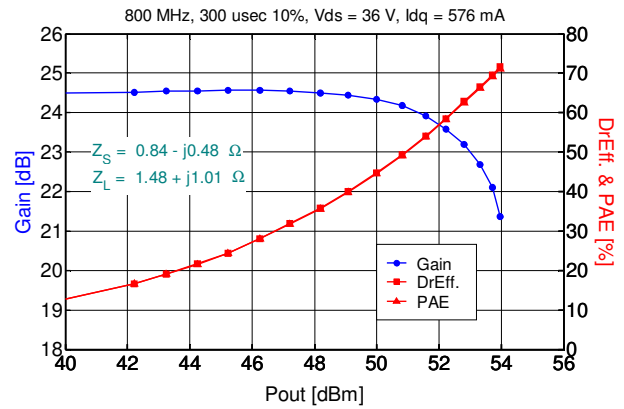
Typical Performance

Performance is based on compromised impedance point and measured at DUT reference plane.

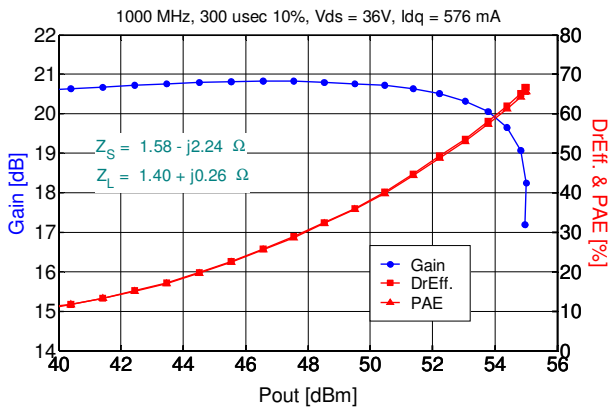
T1G2028536-FL Gain DrEff. and PAE vs. Pout



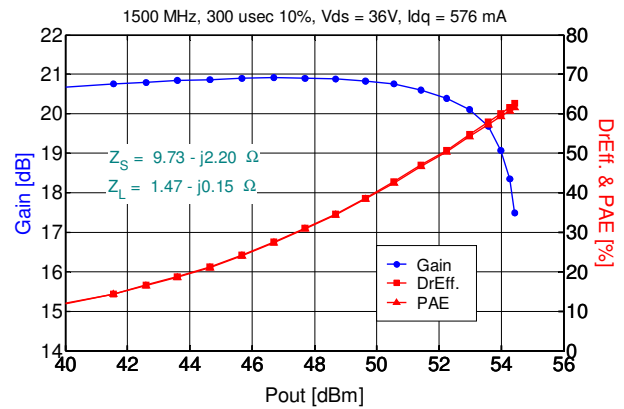
T1G2028536-FL Gain DrEff. and PAE vs. Pout



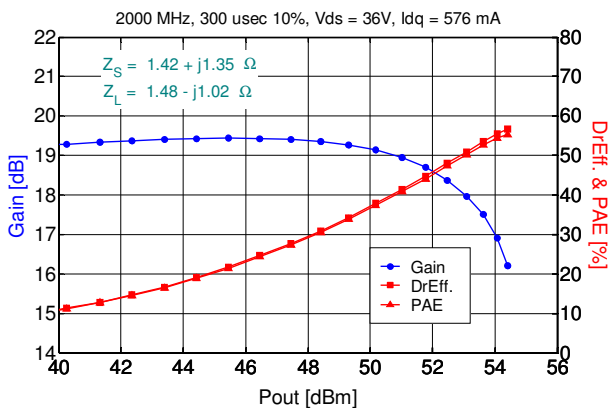
T1G2028536-FL Gain DrEff. and PAE vs. Pout



T1G2028536-FL Gain DrEff. and PAE vs. Pout

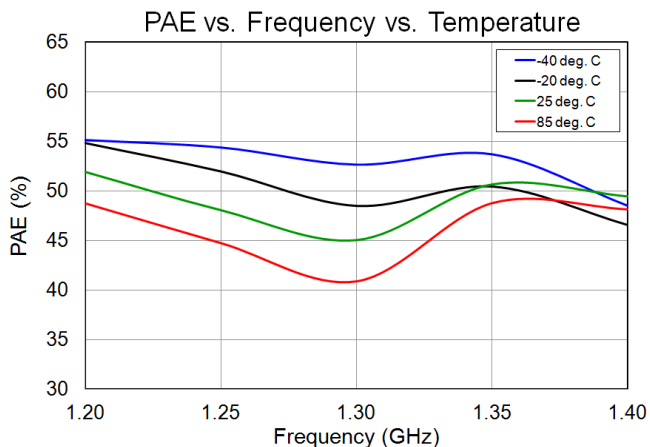
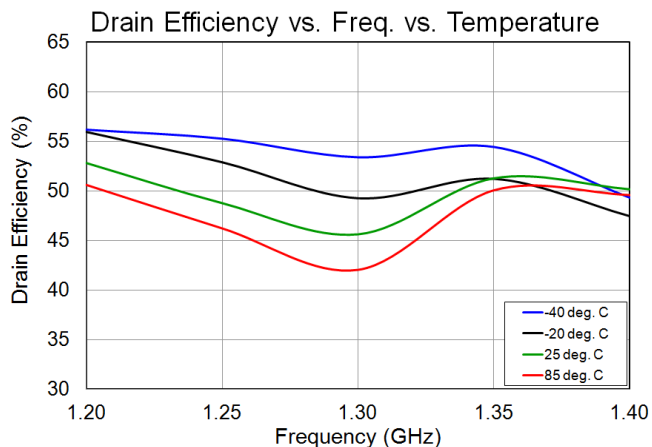
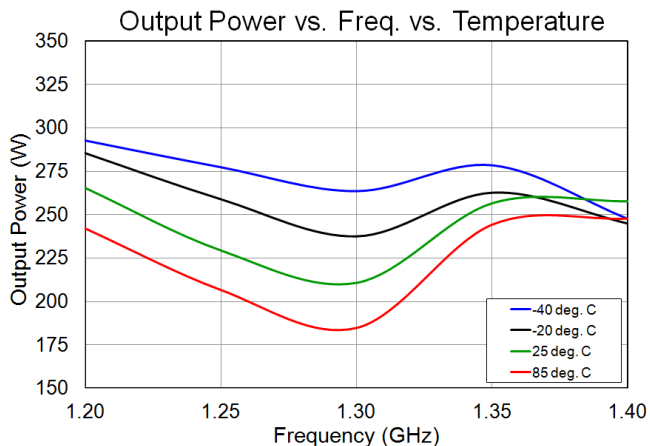
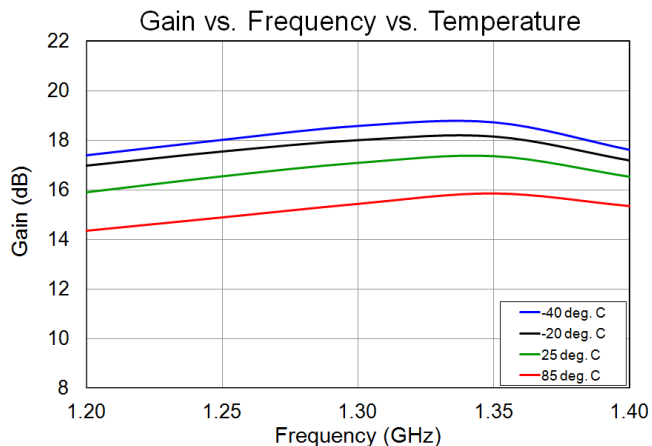


T1G2028536-FL Gain DrEff. and PAE vs. Pout



Performance Over Temperature (1, 2)

Performance measured in TriQuint's 1.2 GHz to 1.4 GHz Evaluation Board at 3 dB compression.

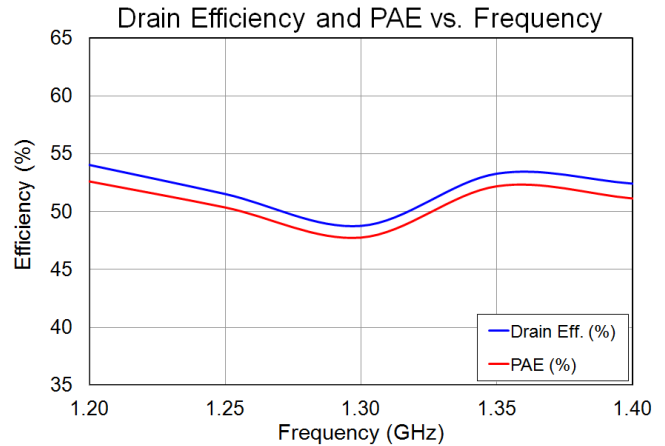
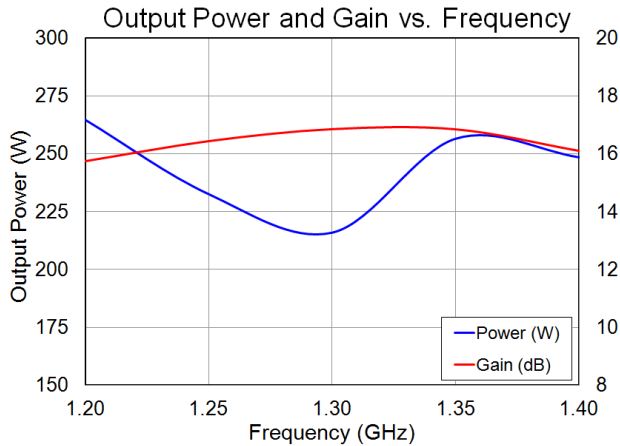


Notes:

1. Test Conditions: $V_{DS} = 36\text{ V}$, $I_{DQ} = 576\text{ mA}$
2. Test Signal: Pulse Width = 300 μs , Duty Cycle = 10%

Evaluation Board Performance ^(1, 2)

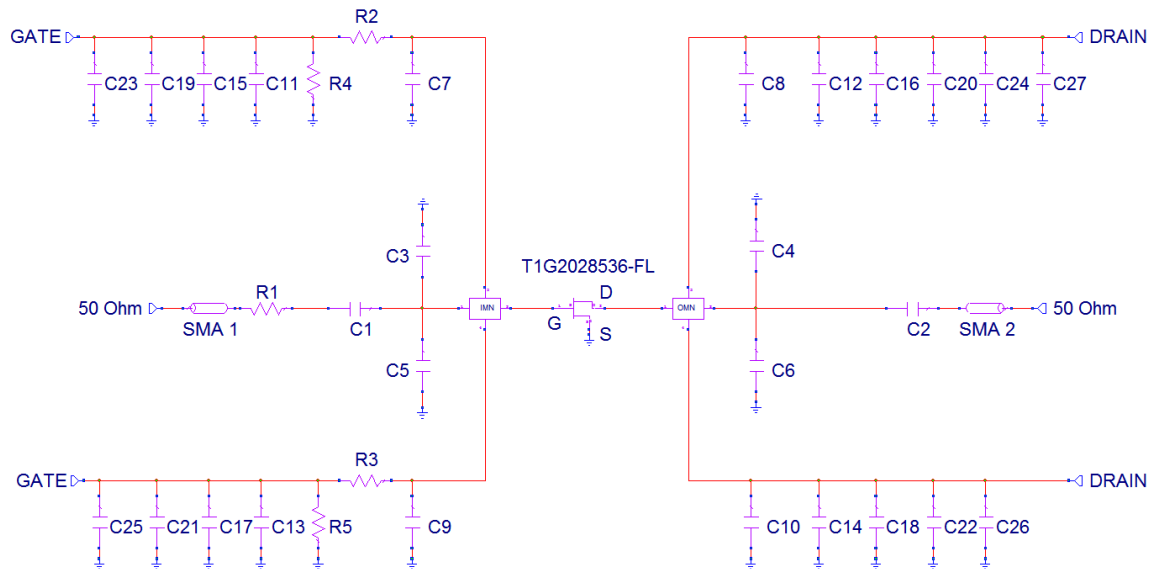
Performance at 3 dB Compression



Notes:

1. Test Conditions: $V_{DS} = 36\text{ V}$, $I_{DQ} = 576\text{ mA}$
2. Test Signal: Pulse Width = 300 μs , Duty Cycle = 10 %

Application Circuit



Bias-up Procedure

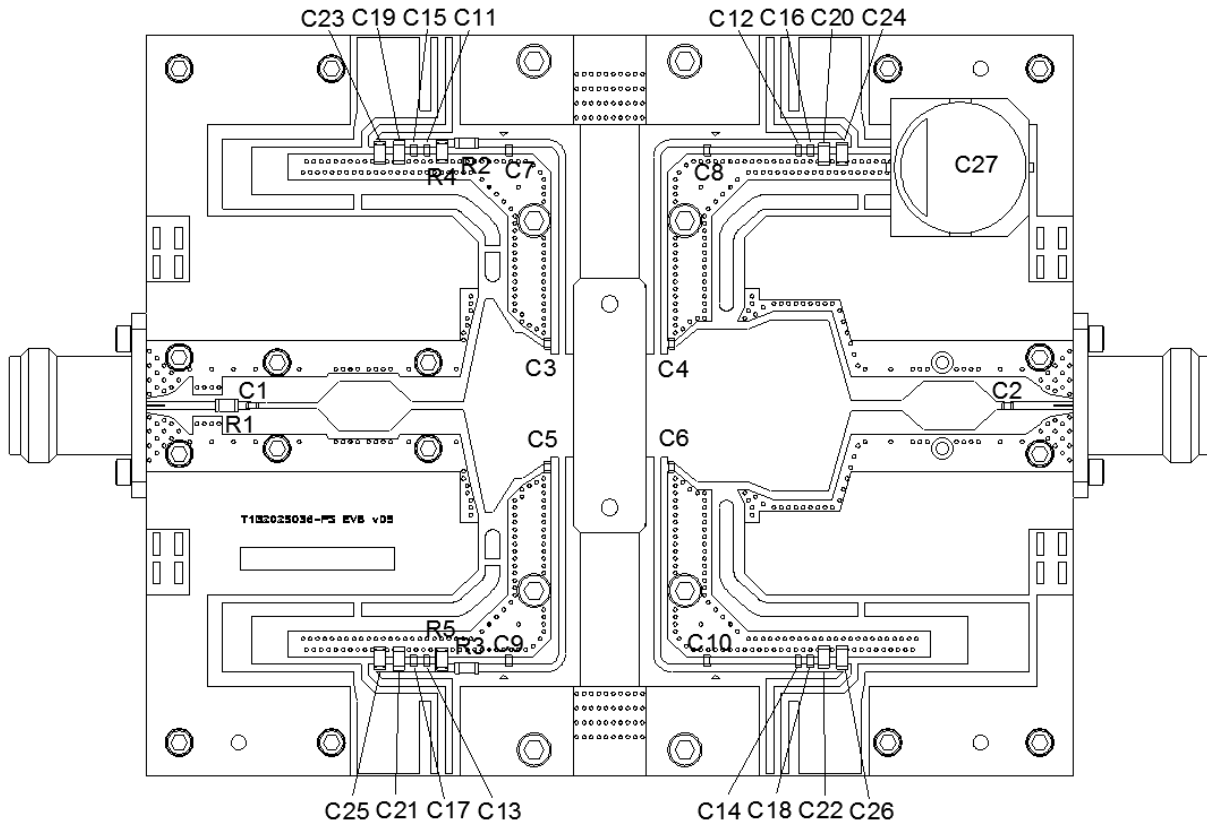
- Set gate voltage (V_G) to -5.0V
- Set drain voltage (V_D) to 36 V
- Slowly increase V_G until quiescent I_D is 576 mA.
- Apply RF signal

Bias-down Procedure

- Turn off RF signal
- Turn off V_D and wait 1 second to allow drain capacitor dissipation
- Turn off V_G

Evaluation Board Layout

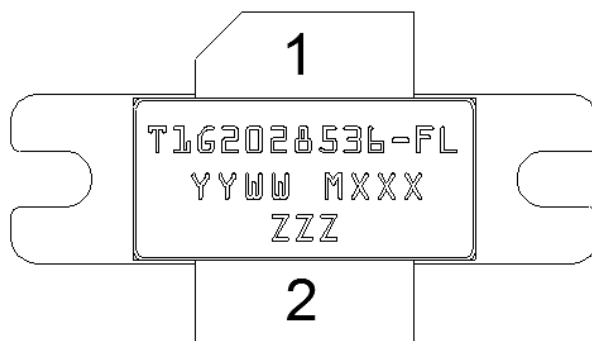
Top RF layer is 0.020" thick Rogers RO4350, $\epsilon_r = 3.48$. The pad pattern shown has been developed and tested for optimized assembly at TriQuint Semiconductor. The PCB land pattern has been developed to accommodate lead and package tolerances.



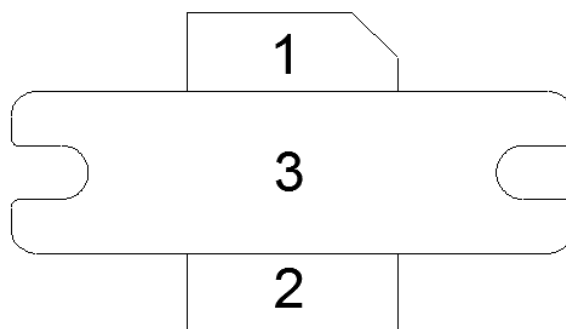
Bill of Materials

Reference Design	Value	Qty	Manufacturer	Part Number
C1, C2, C7, C8, C9, C10	27 pF	6	ATC	600S270FW250XT
C3, C5	3.9 pF	2	ATC	600S3R9AW250XT
C4, C6	4.7 pF	2	ATC	600S4R7AW250XT
C11, C12, C13, C14	2400 pF	4	Murata	C08BL242X-5UN-X0T
C15, C16, C17, C18	100 pF	4	ATC	600S101FW250XT
C19, C20, C21, C22	0.01 uF	4	Kemet	C1206C103KRAC7800
C23, C24, C25, C26	1 uF	4	Allied	18121C105KAT2A
C27	330 uF	1	Cornell Dubilier	AFK337M2AR44T-F
R1, R2, R3	12.1 ohms	3	Vishay Dale	CRCW120612R1FKTA
R4, R5	1000 ohms	2	Vishay Dale	CRCW12061K00FKTA

Pin Layout



TOP VIEW



BOTTOM VIEW

Note:

The T1G2028536-FL will be marked with the “T1G2028536-FL” designator and a lot code marked below the part designator. The “YY” represents the last two digits of the calendar year the part was manufactured, the “WW” is the work week of the assembly lot start, the “MXXX” is the production lot number, and the “ZZZ” is an auto-generated serial number.

Pin Description

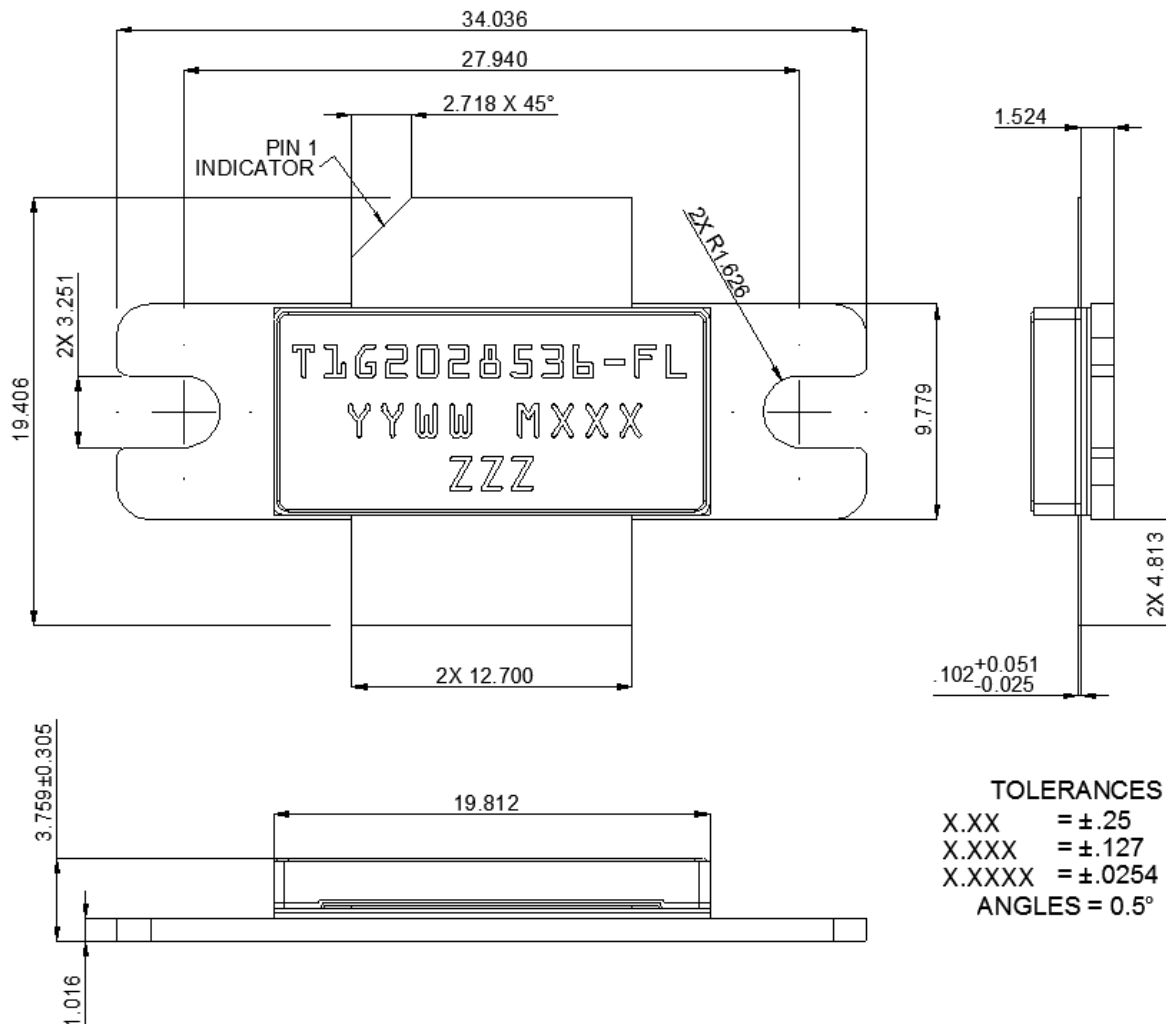
Pin	Symbol	Description
1	V_D / RF OUT	Drain voltage / RF Output matched to 50 ohms; see EVB Layout on page 10 as an example.
2	V_G / RF IN	Gate voltage / RF Input matched to 50 ohms; see EVB Layout on page 10 as an example.
3	Flange	Source connected to ground; see EVB Layout on page 10 as an example.

Notes:

Thermal resistance measured to bottom of package

Mechanical Information

All dimensions are in millimeters.



Note:

This package is lead-free/RoHS-compliant. The plating material on the leads is NiAu. It is compatible with both lead-free (maximum 260 °C reflow temperature) and tin-lead (maximum 245 °C reflow temperature) soldering processes.

Product Compliance Information

ESD Sensitivity Ratings



Caution! ESD-Sensitive Device

ESD Rating: TBD
 Value: TBD
 Test: Human Body Model (HBM)
 Standard: JEDEC Standard JESD22-A114

MSL Rating

Level 3 at +260 °C convection reflow
 The part is rated Moisture Sensitivity Level 3 at 260°C per JEDEC standard IPC/JEDEC J-STD-020.

ECCN

US Department of Commerce EAR99

Solderability

Compatible with the latest version of J-STD-020, Lead free solder, 260° C

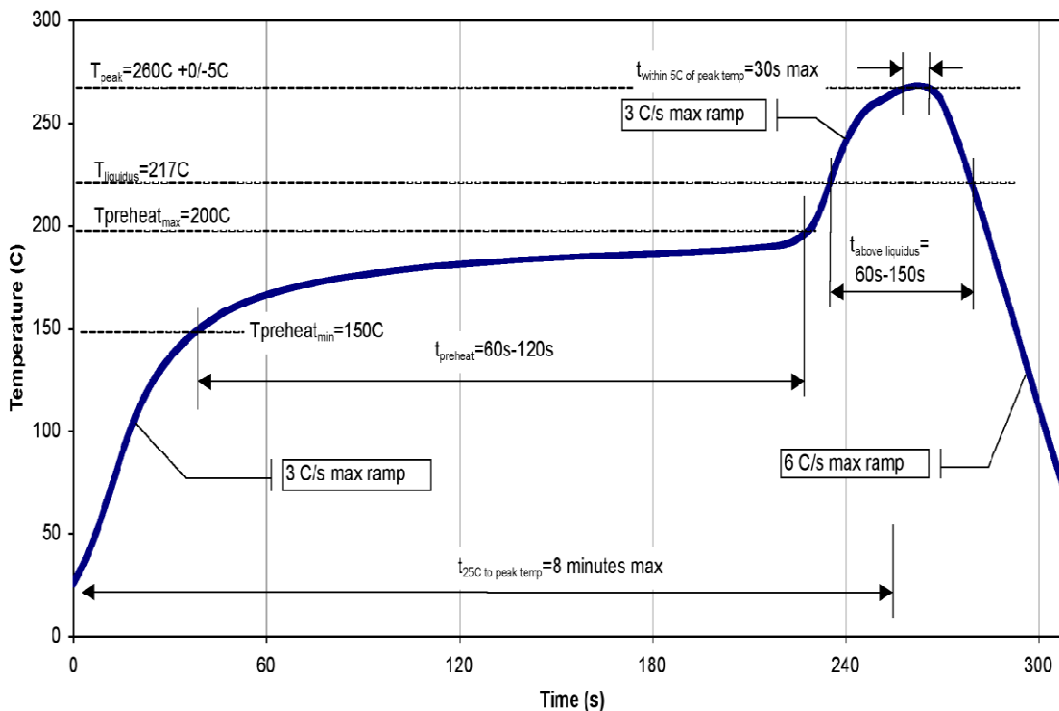
RoHS Compliance

This part is compliant with EU 2002/95/EC RoHS directive (Restrictions on the Use of Certain Hazardous Substances in Electrical and Electronic Equipment).

This product also has the following attributes:

- Lead Free
- Halogen Free (Chlorine, Bromine)
- Antimony Free
- TBBP-A (C₁₅H₁₂Br₄O₂) Free
- PFOS Free
- SVHC Free

Recommended Soldering Temperature Profile



Contact Information

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